Customer No.: 31561

Application No.: 10/604,692

Docket No.: 10156-US-PA

AMENDMENT

To the Claims:

Please amend the claims as follows.

1. (previously presented) A split-gate non-volatile memory cell, comprising:

a substrate;

a charge-trapping layer on the substrate;

a split gate as a whole located over the charge-trapping layer, being a part of one

word line of a non-volatile memory array including the split-gate non-volatile memory

cell; and

a source/drain in the substrate beside the split gate,

wherein the split gate includes at least two neighboring conductive pieces that are

shorted with each other and have two opposite edge portions together causing, in

operation of the memory cell, a locally stronger electric field such that only one coding

region is defined, by the two neighboring conductive pieces, in the charge-trapping layer

around the two opposite edge portions.

Claims 2-3 (canceled).

4. (previously presented) The split-gate non-volatile memory cell of claim 1,

wherein the conductive pieces of the split gate include a pair of conductive spacers and a

conductive layer between the pair of conductive spacers.

5. (original) The split-gate non-volatile memory cell of claim 4, wherein the pair

of conductive spacers are arranged with two substantially vertical sidewalls thereof

adjacent to the source/drain.

6. (original) The split-gate non-volatile memory cell of claim 5, further

comprising an insulator on the source/drain, wherein the pair of conductive spacers are

disposed on the sidewalls of the insulator.

Claim 7 (canceled).

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8. (previously presented) The split-gate non-volatile memory cell of claim 1,

wherein the conductive pieces are separated from each other by a dielectric layer.

9. (original) The split-gate non-volatile memory cell of claim 1, wherein the split

gate comprises polysilicon.

10. (original) The split-gate non-volatile memory cell of claim 1, wherein the

charge-trapping layer comprises a silicon nitride layer disposed between two silicon

oxide layers.

11. (original) The split-gate non-volatile memory cell of claim 1, wherein the

charge-trapping layer comprises aluminum oxide (Al₂O₃).

12. (original) The split-gate non-volatile memory cell of claim 1, wherein the

substrate comprises a p-substrate, and the source/drain comprises an n-type source/drain.

Claims 13-34 (canceled).

35. (currently amended) An operating method of a split-gate non-volatile memory

cell, wherein

the split-gate non-volatile memory cell comprises:

a substrate;

a charge-trapping layer on the substrate;

a split gate as a whole located over the charge-trapping layer, being a part of one

word line of a non-volatile memory array including the split-gate non-volatile memory

cell; and

a source/drain in the substrate beside the split gate,

wherein the split gate includes at least two neighboring conductive pieces that are

shorted with each other and have two opposite edge portions together causing, in

operation of the memory cell, a locally stronger electric field such that only one coding

region is defined, by the two neighboring conductive pieces, in the charge-trapping layer

around the two opposite edge portions;

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and the operating method comprises:

in a programming operation:

applying 0V to the substrate and the source/drain; and

applying a first negative voltage to the split gate, the first negative voltage being sufficiently high for injecting electrons into the coding region; and

in an erasing operation:

applying 0V to the split gate, wherein each conductive piece is at an electric state of 0 V;

floating the source/drain; and

applying a second negative voltage to the substrate, the second-positive negative voltage being sufficiently high for ejecting electrons from the coding region.

- 36. (original) The operating method of claim 35, wherein the first negative voltage is about -10V.
- 37. (original) The operating method of claim 35, wherein the second negative voltage is about -10V.

Claims 38-45 (canceled).